

AA3528VR4AS-C1

3.5 x 2.8 mm Surface Mount LED Lamp



DESCRIPTIONS

- The source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- · Single color
- · Suitable for all SMD assembly and solder process
- · Available on tape and reel
- · Ideal for backlighting
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

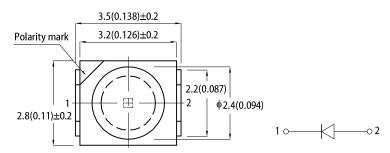
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

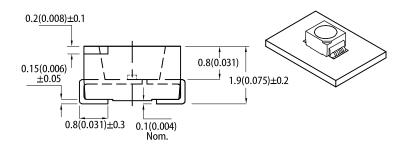
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



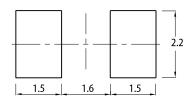
PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Part Number	Emitting Color	Long Type	lv (mcd) @	Viewing Angle [1]	
Part Number	(Material)	Lens Type	Min.	Тур.	2θ1/2
AA3528VR4AS-C1	Cool White (InGaN)	Yellow Fluorescent	1300	1700	120°

Notes.

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
Parameter	Symbol	Emitting Color	Min.	Тур.	Max.	Unit
Color Temperature	ССТ	Cool White	5310	6000	7040	к
Capacitance	С	Cool White	-	100	-	pF
Forward Voltage I _F = 20mA	V _F ^[1]	Cool White	-	3.3	4.0	V
Reverse Current (V _R = 5V)	I _R	Cool White	-	-	50	uA

Notes:

ABSOLUTE MAXIMUM RATINGS at $T_A=25$ °C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	120	mW
Reverse Voltage	V _R	5	V
Junction Temperature	T _j	100	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	100	mA
Electrostatic Discharge Threshold (HBM)	-	250	V

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

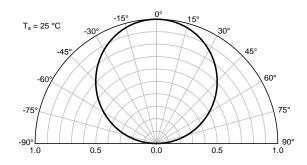


^{1.} Forward voltage: ±0.1V.
2. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

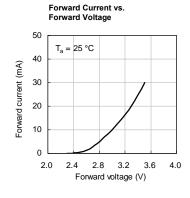


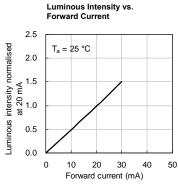
TECHNICAL DATA

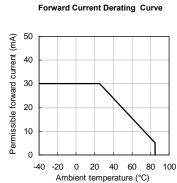
SPATIAL DISTRIBUTION

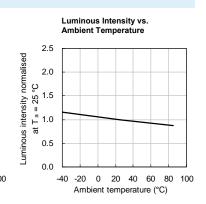


COOL WHITE

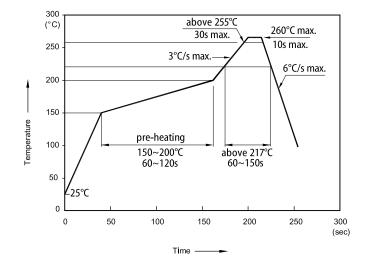








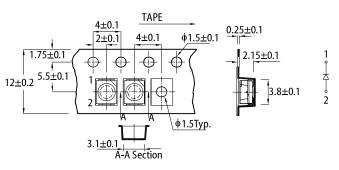
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



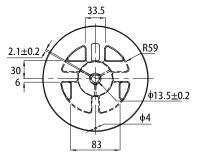
Notes:

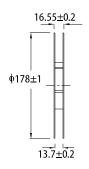
- Don't cause stress to the LEDs while it is exposed to high temperature
 The maximum number of reflow soldering passes is 2 times.
- Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units:mm)



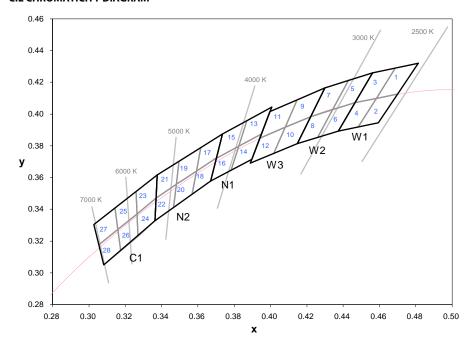
REEL DIMENSION (units: mm)







CIE CHROMATICITY DIAGRAM



Group	Chromaticity Regions	CCT (K)				
	Chromaticity Regions	Min.	Тур.	Max.		
W1	1, 2, 3, 4	2580	2700	2870		
W2	5, 6, 7, 8	2870	3000	3220		
W3	9, 10, 11, 12	3220	3500	3710		

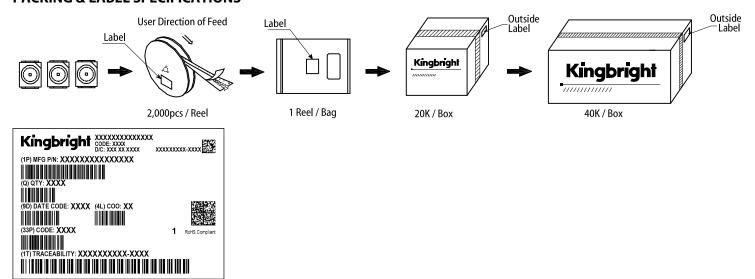
Group	Chromaticity Regions	CCT (K)				
	Officialities Regions	Min.	Тур.	Max.		
N1	13, 14, 15, 16	3710	4000	4260		
N2	17, 18, 19, 20, 21, 22	4260	4700	5310		
C1	23, 24, 25, 26, 27, 28	5310	6000	7040		

Notes: Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.01.

	Х	У		х	У		х	у		х	у
1	0.4582	0.4099	8	0.4147	0.3814	15	0.3702	0.3722	22	0.3481	0.3557
	0.4687	0.4289		0.4221	0.3984		0.3736	0.3874		0.3370	0.3472
	0.4813	0.4319		0.4342	0.4028		0.3869	0.3958		0.3364	0.3328
	0.4700	0.4126		0.4259	0.3853		0.3825	0.3798		0.3466	0.3411
	0.4483	0.3919		0.4080	0.3916	16	0.3670	0.3578	23	0.3376	0.3616
2	0.4582	0.4099	9	0.4146	0.4089		0.3702	0.3722		0.3260	0.3512
2	0.4700	0.4126	9	0.4299	0.4165		0.3825	0.3798		0.3265	0.3371
	0.4593	0.3944		0.4221	0.3984		0.3783	0.3646		0.3370	0.3472
	0.4465	0.4071		0.4017	0.3751	17	0.3736	0.3874	24	0.3370	0.3472
2	0.4562	0.4260	10	0.4080	0.3916		0.3616	0.3788		0.3265	0.3371
3	0.4687	0.4289	10	0.4221	0.3984		0.3592	0.3641		0.3270	0.3230
	0.4582	0.4099		0.4147	0.3814		0.3703	0.3726		0.3364	0.3328
4	0.4373	0.3893	11	0.3941	0.3848	18	0.3703	0.3726	25	0.3260	0.3512
	0.4465	0.4071		0.3996	0.4015		0.3592	0.3641		0.3144	0.3408
	0.4582	0.4099		0.4146	0.4089		0.3568	0.3495		0.3160	0.3274
	0.4483	0.3919		0.4080	0.3916		0.3670	0.3578		0.3265	0.3371
	0.4342	0.4028		0.3889	0.3690		0.3616	0.3788	26	0.3265	0.3371
5	0.4430	0.4212	40	0.3941	0.3848	10	0.3496	0.3702		0.3160	0.3274
5	0.4562	0.4260	12	0.4080	0.3916	19	0.3481	0.3557		0.3175	0.3139
	0.4465	0.4071		0.4017	0.3751		0.3592	0.3641		0.3270	0.3230
	0.4259	0.3853		0.3825	0.3798	20	0.3592	0.3641	27	0.3144	0.3408
6	0.4342	0.4028	40	0.3869	0.3958		0.3481	0.3557		0.3028	0.3304
6	0.4465	0.4071	13	0.4006	0.4044		0.3466	0.3411		0.3055	0.3177
	0.4373	0.3893		0.3950	0.3875		0.3568	0.3495		0.3160	0.3274
	0.4221	0.3984		0.3783	0.3646	21	0.3496	0.3702	28	0.3160	0.3274
7	0.4299	0.4165	4.4	0.3825	0.3798		0.3376	0.3616		0.3055	0.3177
7	0.4430	0.4212	14	0.3950	0.3875		0.3370	0.3472		0.3081	0.3049
	0.4342	0.4028		0.3898	0.3716		0.3481	0.3557		0.3175	0.3139



PACKING & LABEL SPECIFICATIONS

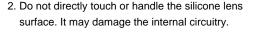


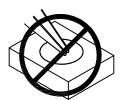
HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



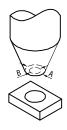




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
- As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

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